

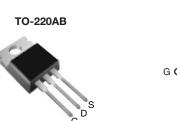
**Vishay Siliconix** 

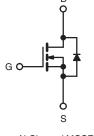
RoH

COMPLIAN<sup>®</sup>

### Power MOSFET

PRODUCT SUMMARY					
V <sub>DS</sub> (V)	100				
R <sub>DS(on)</sub> (Ω)	V <sub>GS</sub> = 10 V 0.077				
Q <sub>g</sub> (Max.) (nC)	72				
Q <sub>gs</sub> (nC)	11				
Q <sub>gd</sub> (nC)	32				
Configuration	Single				





N-Channel MOSFET

#### **FEATURES**

- Dynamic dV/dt Rating
- Repetitive Avalanche Rated
- 175 °C Operating Temperature
- · Fast Switching
- · Ease of Paralleling
- Simple Drive Requirements
- Compliant to RoHS Directive 2002/95/EC

#### DESCRIPTION

Third generation Power MOSFETs from Vishay provide the designer with the best combination of fast switching, ruggedized device design, low on-resistance and cost-effectiveness.

The TO-220AB package is universally preferred for all commercial-industrial applications at power dissipation levels to approximately 50 W. The low thermal resistance and low package cost of the TO-220AB contribute to its wide acceptance throughout the industry.

ORDERING INFORMATION				
Package	TO-220AB			
Lead (Pb)-free	IRF540PbF			
	SiHF540-E3			
SnPb	IRF540			
	SiHF540			

<b>ABSOLUTE MAXIMUM RATINGS</b> ( $T_C = 25 \text{ °C}$ , unless otherwise noted)						
PARAMETER			SYMBOL	LIMIT	UNIT	
Drain-Source Voltage			V <sub>DS</sub>	100	v	
Gate-Source Voltage			V <sub>GS</sub>	± 20	v	
Cantinuous Drain Current	V <sub>GS</sub> at 10 V	T <sub>C</sub> = 25 °C		28		
Continuous Drain Current	VGS at TO V	$T_C = 100 \ ^\circ C$	I <sub>D</sub>	20	А	
Pulsed Drain Current <sup>a</sup>			I <sub>DM</sub>	110		
Linear Derating Factor				1.0	W/°C	
Single Pulse Avalanche Energy <sup>b</sup>			E <sub>AS</sub>	230	mJ	
Repetitive Avalanche Current <sup>a</sup>			I <sub>AR</sub>	28	A	
Repetitive Avalanche Energy <sup>a</sup>			E <sub>AR</sub>	15	mJ	
Maximum Power Dissipation $T_{C} = 25 \text{ °C}$			PD	150	W	
Peak Diode Recovery dV/dt <sup>c</sup>			dV/dt	5.5	V/ns	
Operating Junction and Storage Temperature Range			T <sub>J</sub> , T <sub>stg</sub>	- 55 to + 175	**	
Soldering Recommendations (Peak Temperature)	for	10 s		300 <sup>d</sup>	- °C	
Mounting Taxous	6-32 or M3 screw			10	lbf ∙ in	
Mounting Torque				1.1	N · m	

#### Notes

a. Repetitive rating; pulse width limited by maximum junction temperature (see fig. 11).

b.  $V_{DD} = 25 \text{ V}$ , starting  $T_J = 25 \text{ °C}$ ,  $L = 440 \text{ }\mu\text{H}$ ,  $R_g = 25 \Omega$ ,  $I_{AS} = 28 \text{ A}$  (see fig. 12).

c.  $I_{SD} \le 28$  A, dI/dt  $\le 170$  A/µs,  $V_{DD} \le V_{DS}$ ,  $T_J \le 175$  °C.

d. 1.6 mm from case.

\* Pb containing terminations are not RoHS compliant, exemptions may apply

Document Number: 91021 S11-0510-Rev. B, 21-Mar-11 www.vishay.com

This detected to cubicat to change without potice. THE PRODUCT DESCRIBED HEREIN AND THIS DATASH Downloaded From Oneyac.com AIMERS, SET FORTH AT www.vishav.com/doc?91000

# Vishay Siliconix



THERMAL RESISTANCE RATINGS								
PARAMETER	SYMBOL	TYP.		MAX.		UNIT		
Maximum Junction-to-Ambient	R <sub>thJA</sub>	-		62 - 1.0				
Case-to-Sink, Flat, Greased Surface	R <sub>thCS</sub>	0.50				°C/W		
Maximum Junction-to-Case (Drain)	R <sub>thJC</sub>	-						
<b>SPECIFICATIONS</b> ( $T_J = 25 \ ^{\circ}C$ , u	nless otherw	ise noted)						
PARAMETER	SYMBOL	TEST	CONDIT	IONS	MIN.	TYP.	MAX.	UNIT
Static		•				•	1	0
Drain-Source Breakdown Voltage	V <sub>DS</sub>	$V_{GS} = 0$	) V, I <sub>D</sub> = 2	250 µA	100	-	-	V
V <sub>DS</sub> Temperature Coefficient	$\Delta V_{DS}/T_{J}$	Reference	to 25 °C	, I <sub>D</sub> = 1 mA	-	0.13	-	V/°C
Gate-Source Threshold Voltage	V <sub>GS(th)</sub>	$V_{DS} = V$	′ <sub>GS</sub> , I <sub>D</sub> = 2	250 μΑ	2.0	-	4.0	V
Gate-Source Leakage	I <sub>GSS</sub>	VG	<sub>iS</sub> = ± 20	V	-	-	± 100	nA
Zero Gate Voltage Drain Current	I <sub>DSS</sub>	V <sub>DS</sub> = 1	00 V, V <sub>G</sub>	<sub>S</sub> = 0 V	-	-	25	μA
	1055	V <sub>DS</sub> = 80 V, V	<sub>GS</sub> = 0 V	, T <sub>J</sub> = 150 °C	-	-	250	μΛ
Drain-Source On-State Resistance	R <sub>DS(on)</sub>	$V_{GS} = 10 V$		I <sub>D</sub> = 17 A <sup>b</sup>	-	-	0.077	Ω
Forward Transconductance	g <sub>fs</sub>	$V_{DS} = 50 \text{ V}, \text{ I}_{D} = 17 \text{ A}^{b}$		8.7	-	-	S	
Dynamic					-	-		
Input Capacitance	C <sub>iss</sub>	V	′ <sub>GS</sub> = 0 V	,	-	1700	-	
Output Capacitance	C <sub>oss</sub>	V <sub>DS</sub> = 25 V,		-	560	-	pF	
Reverse Transfer Capacitance	C <sub>rss</sub>	f = 1.0 MHz, see fig. 5		-	120	-		
Total Gate Charge	Qg	$V_{GS} = 10 V$ $I_D = 17 A, V_{DS} = 80 V,$			-	-	72	
Gate-Source Charge	Q <sub>gs</sub>			-	-	11	nC	
Gate-Drain Charge	Q <sub>gd</sub>		see fig. 6 and 13 <sup>b</sup>		-	-	32	
Turn-On Delay Time	t <sub>d(on)</sub>				-	11	-	<u> </u>
Rise Time	t <sub>r</sub>	$\label{eq:VDD} \begin{array}{l} V_{DD}=50 \text{ V}, \text{ I}_{D}=17 \text{ A} \\ R_{g}=9.1 \ \Omega, \ R_{D}=2.9 \ \Omega, \ \text{see fig. } 10^{b} \end{array}$		-	44	-	- ns	
Turn-Off Delay Time	t <sub>d(off)</sub>			-	53	-		
Fall Time	t <sub>f</sub>			-	43	-		
Internal Drain Inductance	L <sub>D</sub>	Between lead, 6 mm (0.25") from package and center of die contact		-	4.5	-		
Internal Source Inductance	L <sub>S</sub>			-	7.5	-	nH	
Drain-Source Body Diode Characteristic	cs							
Continuous Source-Drain Diode Current	I <sub>S</sub>	MOSFET symbol showing the integral reverse p - n junction diode		-	-	28	A	
Pulsed Diode Forward Current <sup>a</sup>	I <sub>SM</sub>			-	-	110	~	
Body Diode Voltage	$V_{SD}$	$T_J = 25 \ ^{\circ}C, \ I_S = 28 \ A, \ V_{GS} = 0 \ V^b$		-	-	2.5	V	
Body Diode Reverse Recovery Time	t <sub>rr</sub>	- T <sub>J</sub> = 25 °C, I <sub>F</sub> = 17 A, dl/dt = 100 A/μs <sup>b</sup>		-	180	360	ns	
Body Diode Reverse Recovery Charge	Q <sub>rr</sub>			-	1.3	2.8	μC	
Forward Turn-On Time	t <sub>on</sub>	Intrinsic turn-on time is negligible (turn						

#### Notes

a. Repetitive rating; pulse width limited by maximum junction temperature (see fig. 11).

b. Pulse width  $\leq$  300 µs; duty cycle  $\leq$  2 %.

www.vishay.com 2 Document Number: 91021 S11-0510-Rev. B, 21-Mar-11

This datashast is subject to shares without notice. THE PRODUCT DESCRIBED HEREIN AND THIS DATASHEE Downloaded From Oneyac.com // MERS, SET FORTH AT www.vishay.com/doc?91000



**Vishay Siliconix** 



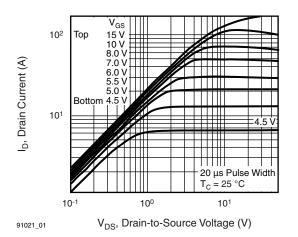


Fig. 1 - Typical Output Characteristics,  $T_C = 25 \ ^{\circ}C$ 

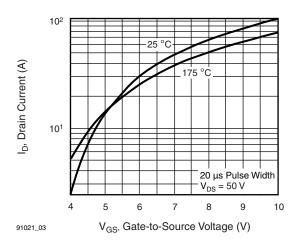


Fig. 3 - Typical Transfer Characteristics

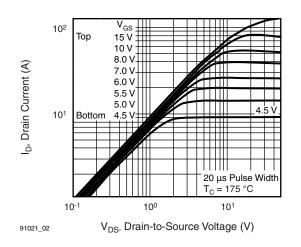


Fig. 2 - Typical Output Characteristics, T<sub>C</sub> = 175 °C

THE PRODUCT DESCRIBED HEREIN AND THIS DATASH Downloaded From Oneyac.com

This detection of the change without active.

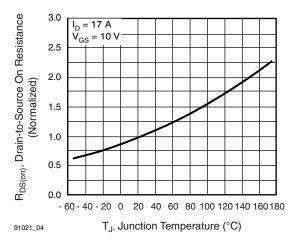


Fig. 4 - Normalized On-Resistance vs. Temperature

AIMERS, SET FORTH AT www.vishay.com/doc?91000

Vishay Siliconix



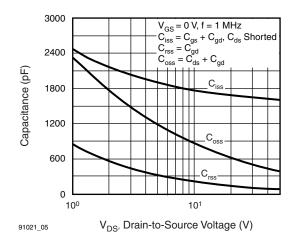


Fig. 5 - Typical Capacitance vs. Drain-to-Source Voltage

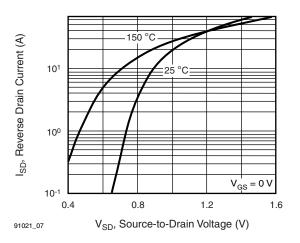


Fig. 7 - Typical Source-Drain Diode Forward Voltage

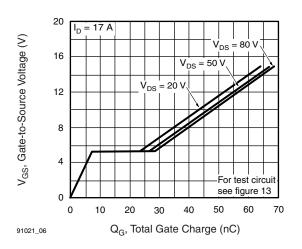


Fig. 6 - Typical Gate Charge vs. Gate-to-Source Voltage

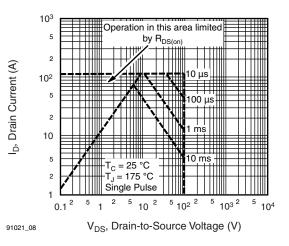


Fig. 8 - Maximum Safe Operating Area

Document Number: 91021 S11-0510-Rev. B, 21-Mar-11

This datasheet is subject to shance without patice.
THE PRODUCT DESCRIBED HEREIN AND THIS DATASHEE Downloaded From Oneyac.com // MERS, SET FORTH AT www.vishay.com/doc?91000



### Vishay Siliconix

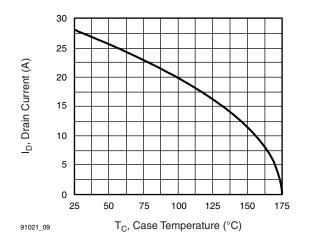


Fig. 9 - Maximum Drain Current vs. Case Temperature

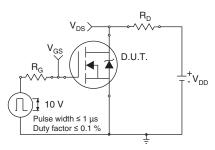


Fig. 10a - Switching Time Test Circuit

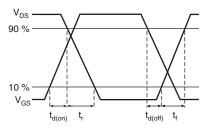


Fig. 10b - Switching Time Waveforms

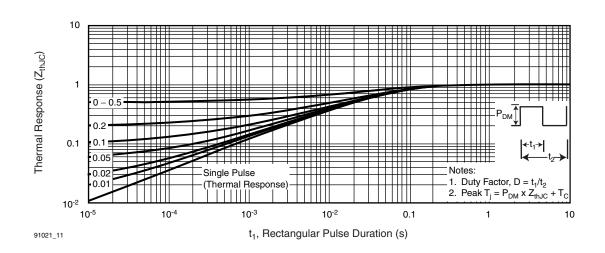


Fig. 11 - Maximum Effective Transient Thermal Impedance, Junction-to-Case

This detection of the change without active.

THE PRODUCT DESCRIBED HEREIN AND THIS DATASH Downloaded From Oneyac.com

AIMERS, SET FORTH AT www.vishay.com/doc?91000

### Vishay Siliconix



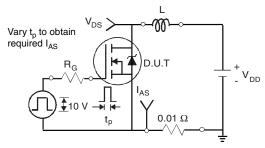


Fig. 12a - Unclamped Inductive Test Circuit

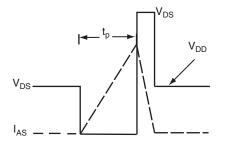


Fig. 12b - Unclamped Inductive Waveforms

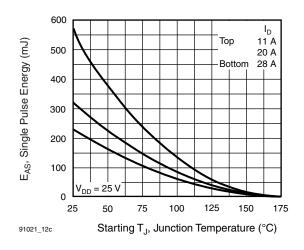


Fig. 12c - Maximum Avalanche Energy vs. Drain Current

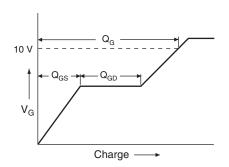


Fig. 13a - Basic Gate Charge Waveform

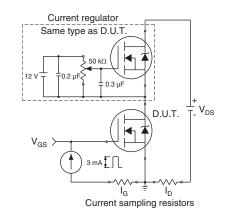
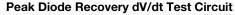
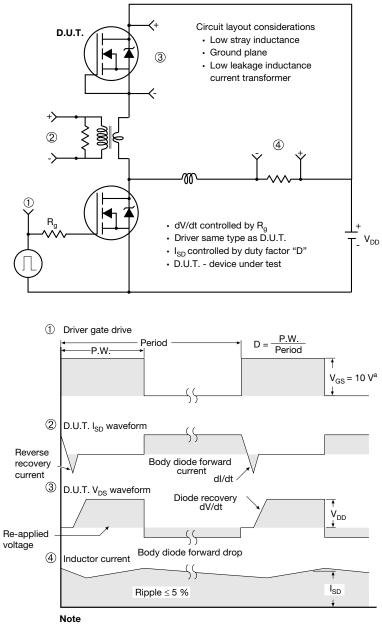


Fig. 13b - Gate Charge Test Circuit



#### **Vishay Siliconix**





a.  $V_{GS} = 5 V$  for logic level devices

Fig. 14 - For N-Channel

Vishay Siliconix maintains worldwide manufacturing capability. Products may be manufactured at one of several qualified locations. Reliability data for Silicon Technology and Package Reliability represent a composite of all qualified locations. For related documents such as package/tape drawings, part marking, and reliability data, see <a href="http://www.vishay.com/ppg?91021">http://www.vishay.com/ppg?91021</a>.

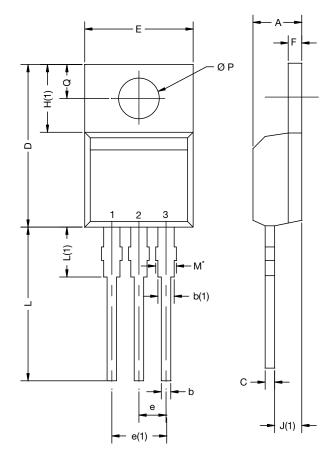
Document Number: 91021 S11-0510-Rev. B, 21-Mar-11

AIMERS, SET FORTH AT <u>www.vishay.com/doc?91000</u>



VISHAY www.vishay.com

**TO-220-1** 



DIM.	MILLIN	IETERS	INCHES		
DIIVI.	MIN.	MAX.	MIN.	MAX.	
А	4.24	4.65	0.167	0.183	
b	0.69	1.02	0.027	0.040	
b(1)	1.14	1.78	0.045	0.070	
С	0.36	0.61	0.014	0.024	
D	14.33	15.85	0.564	0.624	
Е	9.96	10.52	0.392	0.414	
е	2.41	2.67	0.095	0.105	
e(1)	4.88	5.28	0.192	0.208	
F	1.14	1.40	0.045	0.055	
H(1)	6.10	6.71	0.240	0.264	
J(1)	2.41	2.92	0.095	0.115	
L	13.36	14.40	0.526	0.567	
L(1)	3.33	4.04	0.131	0.159	
ØΡ	3.53	3.94	0.139	0.155	
Q	2.54	3.00	0.100	0.118	
ECN: X15-0364-Rev. C, 14-Dec-15 DWG: 6031					

Note

•  $M^* = 0.052$  inches to 0.064 inches (dimension including protrusion), heatsink hole for HVM

Package Picture						
ASE		Xi'an				
		IRF 9510 744K AB				

Revison: 14-Dec-15

Document Number: 66542

THIS DOCUMENT IS SUBJECT TO CHANGE WITHOUT NOTICE. THE PRODUCTS DESCRIBED HEREIN AND THIS DOCUMENT ARE SUBJECT TO SPECIFI Downloaded From Oneyac.com



Vishay

### Disclaimer

ALL PRODUCT, PRODUCT SPECIFICATIONS AND DATA ARE SUBJECT TO CHANGE WITHOUT NOTICE TO IMPROVE RELIABILITY, FUNCTION OR DESIGN OR OTHERWISE.

Vishay Intertechnology, Inc., its affiliates, agents, and employees, and all persons acting on its or their behalf (collectively, "Vishay"), disclaim any and all liability for any errors, inaccuracies or incompleteness contained in any datasheet or in any other disclosure relating to any product.

Vishay makes no warranty, representation or guarantee regarding the suitability of the products for any particular purpose or the continuing production of any product. To the maximum extent permitted by applicable law, Vishay disclaims (i) any and all liability arising out of the application or use of any product, (ii) any and all liability, including without limitation special, consequential or incidental damages, and (iii) any and all implied warranties, including warranties of fitness for particular purpose, non-infringement and merchantability.

Statements regarding the suitability of products for certain types of applications are based on Vishay's knowledge of typical requirements that are often placed on Vishay products in generic applications. Such statements are not binding statements about the suitability of products for a particular application. It is the customer's responsibility to validate that a particular product with the properties described in the product specification is suitable for use in a particular application. Parameters provided in datasheets and / or specifications may vary in different applications and performance may vary over time. All operating parameters, including typical parameters, must be validated for each customer application by the customer's technical experts. Product specifications do not expand or otherwise modify Vishay's terms and conditions of purchase, including but not limited to the warranty expressed therein.

Except as expressly indicated in writing, Vishay products are not designed for use in medical, life-saving, or life-sustaining applications or for any other application in which the failure of the Vishay product could result in personal injury or death. Customers using or selling Vishay products not expressly indicated for use in such applications do so at their own risk. Please contact authorized Vishay personnel to obtain written terms and conditions regarding products designed for such applications.

No license, express or implied, by estoppel or otherwise, to any intellectual property rights is granted by this document or by any conduct of Vishay. Product names and markings noted herein may be trademarks of their respective owners.



单击下面可查看定价,库存,交付和生命周期等信息

>>Vishay(威世)